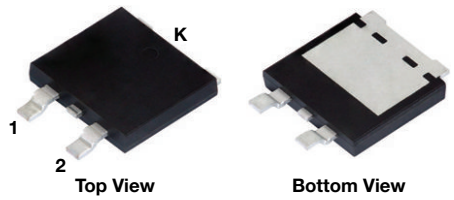
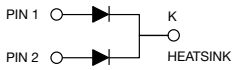
Dual Trench MOS Barrier Schottky Rectifier

Ultra Low V_F = 0.29 V at I_F = 5 A

TMBS® eSMP® Series
TO-263AC (SMPD)





FEATURES

- Trench MOS Schottky technology
- Very low profile - typical height of 1.7 mm
- Ideal for automated placement
- Low forward voltage drop, low power losses
- High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
  - Automotive ordering code; base P/NHM3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

RoHS COMPLIANT
HALOGEN FREE

TYPICAL APPLICATIONS

For use in high frequency DC/DC converters, switching power supplies, freewheeling diodes, OR-ing diode, and reverse battery protection.

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	2 x 15 A
V_{RRM}	50 V
I_{FSM}	300 A
V_F at I_F = 15 A	0.42 V
T_J max.	150 °C
Package	TO-263AC (SMPD)
Diode variations	Dual common cathode

MECHANICAL DATA

Case: TO-263AC (SMPD)
Molding compound meets UL 94 V-0 flammability rating
Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade
Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified
Base P/NHM3_X - halogen-free, RoHS-compliant, and AEC-Q101 qualified
("_X" denotes revision code e.g. A, B,.....)

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102
M3 suffix meets JESD 201 class 1A whisker test, HM3 suffix meets JESD 201 class 2 whisker test

Polarity: as marked

MAXIMUM RATINGS (T_A = 25 °C unless otherwise noted)				
PARAMETER		**SYMBOL**	**V30DL50C**	**UNIT**
Maximum repetitive peak reverse voltage		V_{RRM}	50	V
Maximum average forward rectified current (fig. 1)	per device	$I_{F(AV)}$	30	A
	per diode		15	
Peak forward surge current 10 ms single half sine-wave superimposed on rated load		I_{FSM}	300	A
Operating junction and storage temperature range		T_J, T_{STG}	-40 to +150	°C

ELECTRICAL CHARACTERISTICS (T_A = 25 °C unless otherwise noted)						
PARAMETER	**TEST CONDITIONS**		**SYMBOL**	**TYP.**	**MAX.**	**UNIT**
Instantaneous forward voltage per diode	I_F = 5 A	T_A = 25 °C	V_F (1)	0.39	-	V
	I_F = 7.5 A			0.42	-	
	I_F = 15 A			0.49	0.57	
	I_F = 5 A	T_A = 125 °C		0.29	-	
	I_F = 7.5 A			0.33	-	
	I_F = 15 A			0.42	0.50	
Reverse current per diode	V_R = 50 V	T_A = 25 °C	I_R (2)	-	1800	µA
		T_A = 125 °C		25	60	mA
Typical junction capacitance	4.0 V, 1 MHz	T_A = 25 °C	C_J	2800	-	pF

Notes

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

(2) Pulse test: pulse width ≤ 40 ms

THERMAL CHARACTERISTICS (T_A = 25 °C unless otherwise noted)				
PARAMETER		**SYMBOL**	**V30DL50C**	**UNIT**
Typical thermal resistance	per diode	$R_{\theta JC}$	1.7	°C/W
	per device		0.9	
	per device	$R_{\theta JA}$ (1)(2)	45	

Notes

(1) The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$

(2) Free air, without heatsink

ORDERING INFORMATION (Example)				
PREFERRED P/N	**UNIT WEIGHT (g)**	**PREFERRED PACKAGE CODE**	**BASE QUANTITY**	**DELIVERY MODE**
V30DL50C-M3/I	0.55	I	2000/reel	13" diameter plastic tape and reel
V30DL50CHM3/I (1)	0.55	I	2000/reel	13" diameter plastic tape and reel
V30DL50CHM3_A/I (1)	0.55	I	2000/reel	13" diameter plastic tape and reel

Note

(1) AEC-Q101 qualified

RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

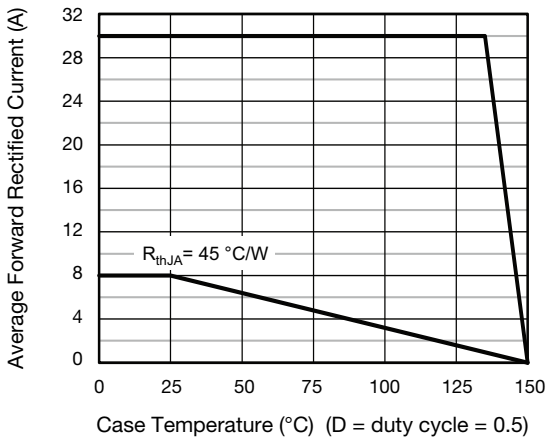


Fig. 1 - Forward Current Derating Curve

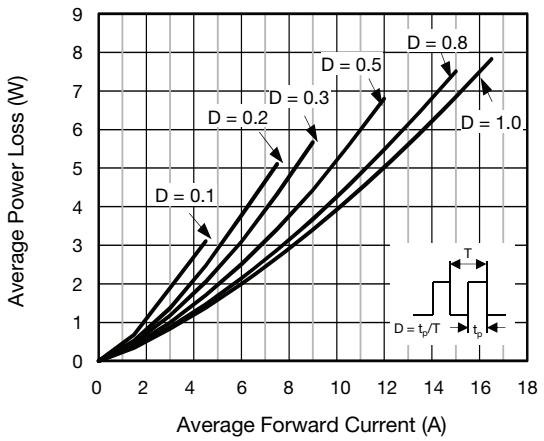


Fig. 2 - Forward Power Loss Characteristics Per Diode

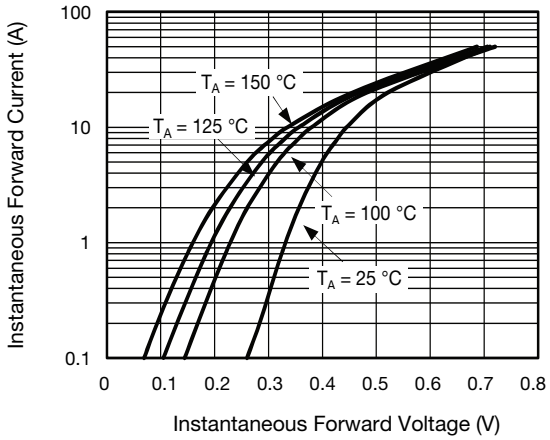


Fig. 3 - Typical Instantaneous Forward Characteristics Per Diode

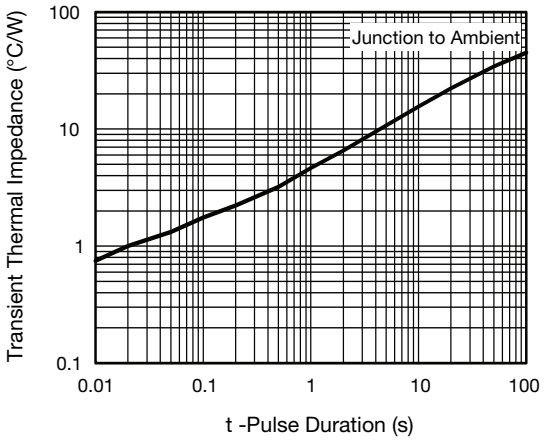


Fig. 6 - Typical Transient Thermal Impedance Per Device

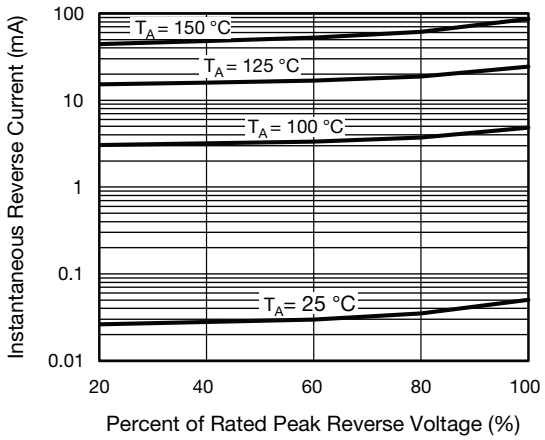


Fig. 4 - Typical Reverse Characteristics Per Diode

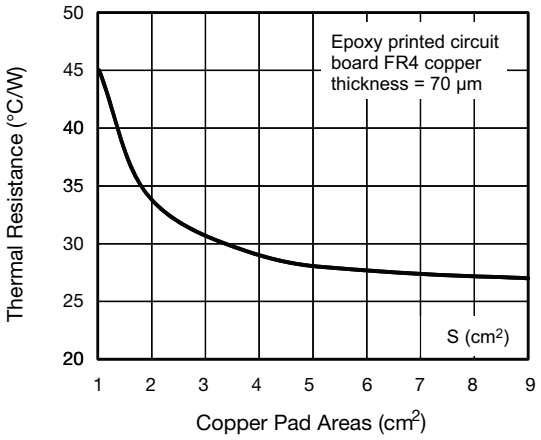


Fig. 7 - Thermal Resistance Junction-to-Ambient vs. Copper Pad Areas

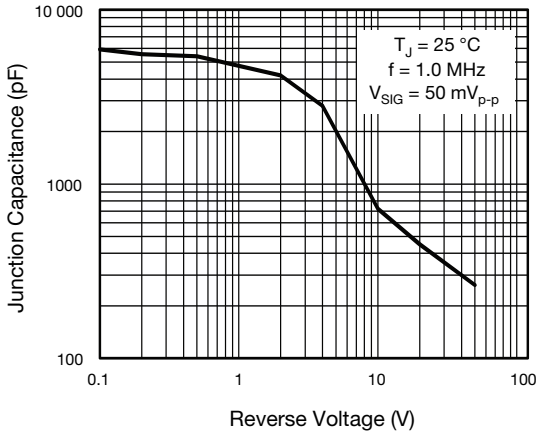
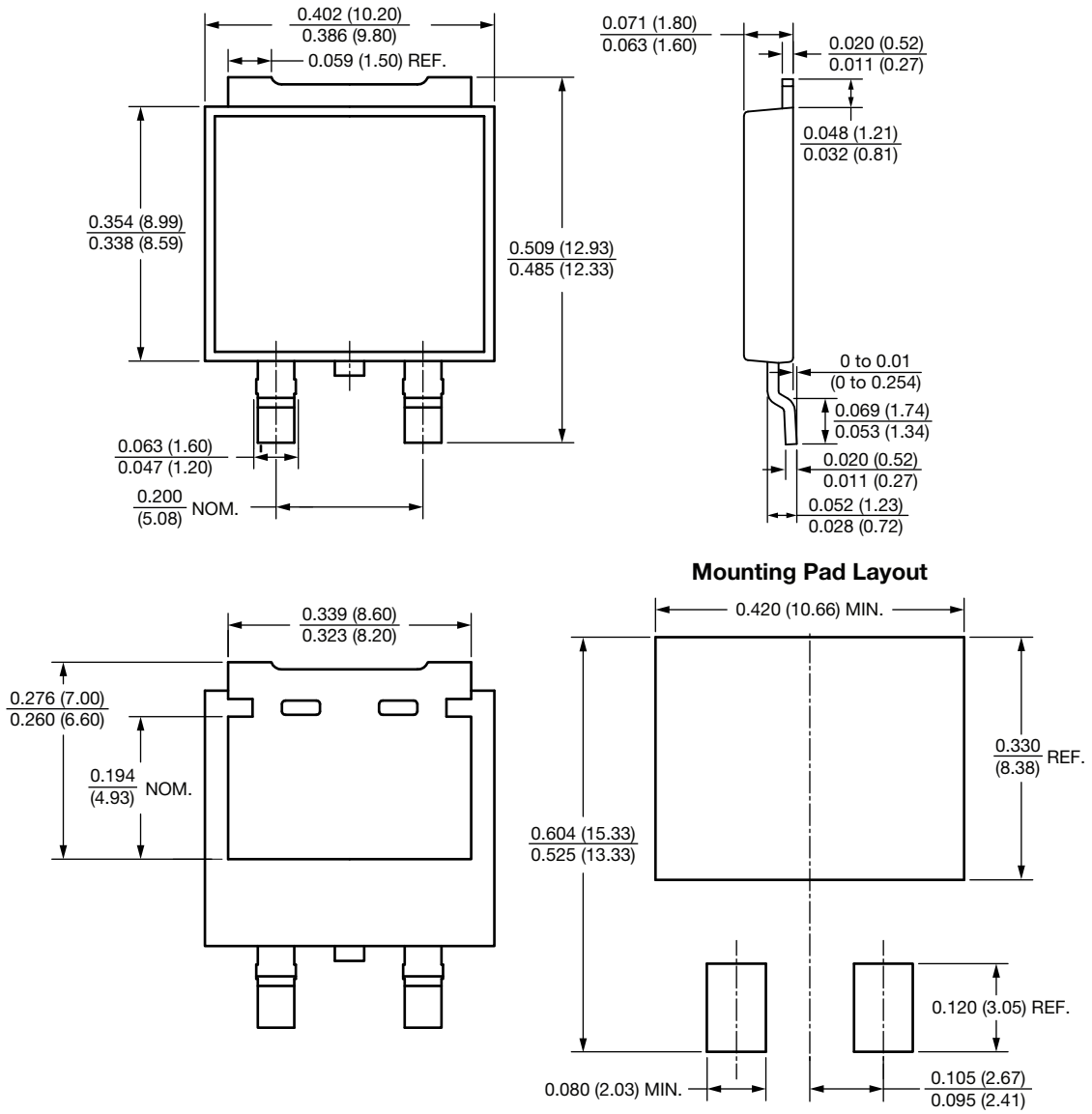


Fig. 5 - Typical Junction Capacitance Per Diode

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

TO-263AC (SMPD)



Mounting Pad Layout

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